

Silicon Diode

FESF8CT

Fast Efficient Rectifier

150V / 8A

DATASHEET

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OEM – General Semiconductor

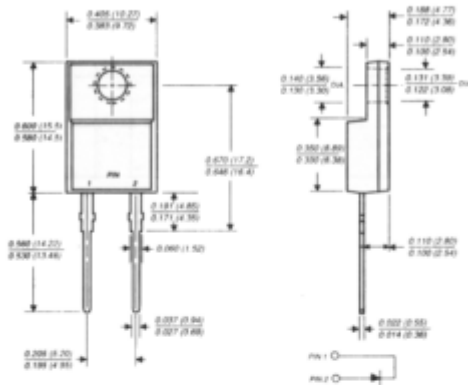
Source: General Semiconductor Databook 1998

NEW PRODUCT NEW PRODUCT NEW PRODUCT

FESF8AT THRU FESF8JT

FAST EFFICIENT PLASTIC RECTIFIER
Reverse Voltage - 50 to 600 Volts Forward Current - 8.0 Amperes

ITO-220AC



Dimensions in inches and (millimeters)

FEATURES

- ◆ Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- ◆ Glass passivated chip junction
- ◆ Low leakage, high voltage
- ◆ High surge current capability
- ◆ Superfast recovery time, for high efficiency
- ◆ High temperature soldering guaranteed: 250°C, 0.25" (6.35mm) from case for 10 seconds



MECHANICAL DATA

Case: JEDEC ITO-220AC fully overmolded plastic body over passivated chip
Terminals: Plated lead solderable per MIL-STD-750, Method 2026
Polarity: As marked
Mounting Position: Any
Weight: 0.064 ounce, 1.81 grams
Mounting Torque: 5 in. - lbs. max.

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified

	SYMBOLS	FESF 8AT	FESF 8BT	FESF 8CT	FESF 8DT	FESF 8FT	FESF 8GT	FESF 8HT	FESF 8JT	UNITS
Maximum recurrent peak reverse voltage	V _{RRM}	50	100	150	200	300	400	500	600	Volts
Maximum RMS voltage	V _{RMS}	35	70	105	140	210	280	350	420	Volts
Maximum DC blocking voltage	V _{DC}	50	100	150	200	300	400	500	600	Volts
Maximum average forward rectified current at T _C =100°C	I _(AV)	8.0								Amps
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	125.0								Amps
Maximum instantaneous forward voltage at 8.0A	V _F	0.95		1.3		1.5				Volts
Maximum DC reverse current at rated DC blocking voltage T _C =25°C at T _C =100°C	I _R	10.0 500.0								µA
Maximum reverse recovery time (NOTE 1)	t _{rr}	35.0			50.0					ns
Typical junction capacitance (NOTE 2)	C _J	85.0					60.0			pF
Typical thermal resistance (NOTE 3)	R _{θJC}	5.0								°C/W
Operating junction and storage temperature range	T _J , T _{STG}	-65 to +150								°C

NOTES:
 (1) Reverse recovery test conditions: I_R=0.5A, I_{sm}=1.0A, I_{sm}=0.25A
 (2) Measured at 1.0 MHz and applied reverse voltage of 4.0 Volts
 (3) Thermal resistance from junction to case mounted on heatsink

RATINGS AND CHARACTERISTIC CURVES FESF8AT THRU FESF8JT

FIG. 1 - MAXIMUM FORWARD CURRENT DERATING CURVES

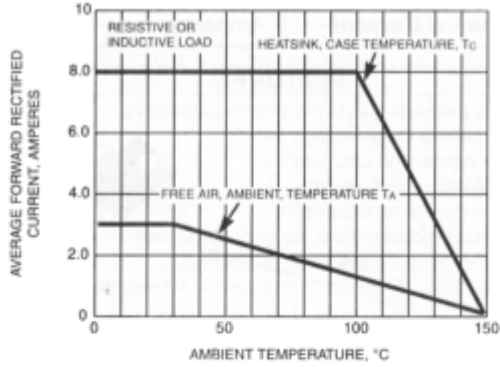


FIG. 2 - MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

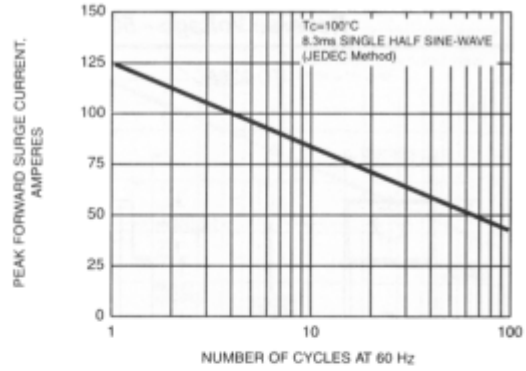


FIG. 3 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

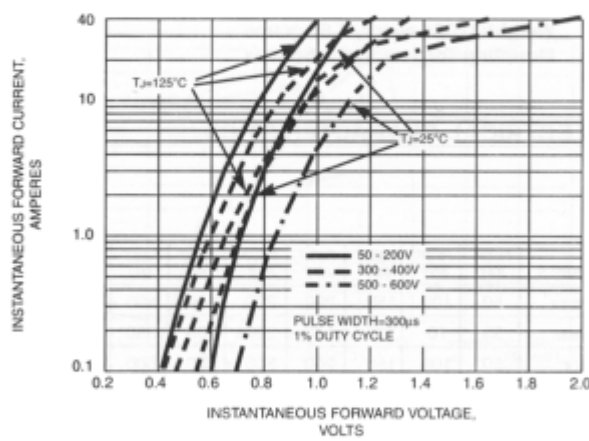


FIG. 4 - TYPICAL REVERSE LEAKAGE CHARACTERISTICS

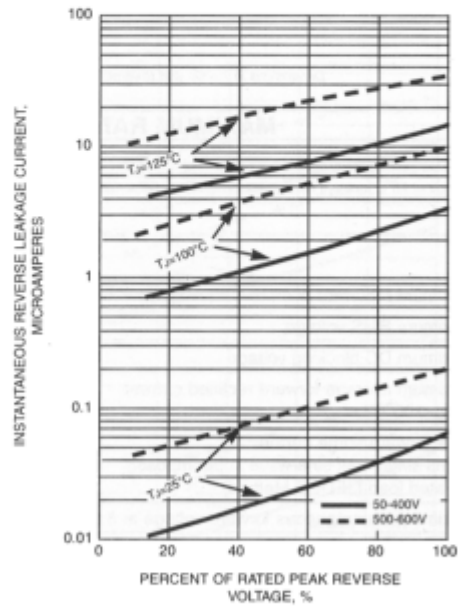


FIG. 5 - TYPICAL JUNCTION CAPACITANCE

